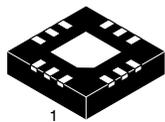


WQFN12 3x3, 0.5P
CASE 510AH
ISSUE O

DATE 20 JAN 2009

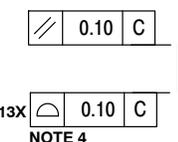


SCALE 4:1

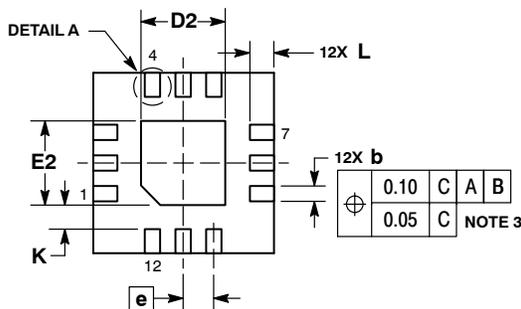
PIN ONE REFERENCE



TOP VIEW

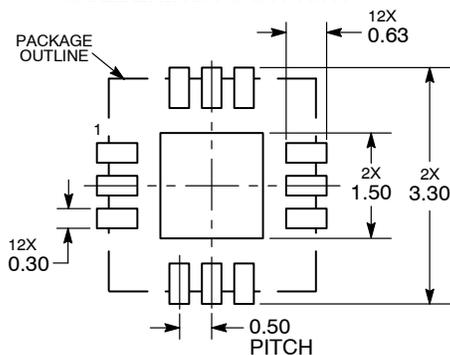


SIDE VIEW

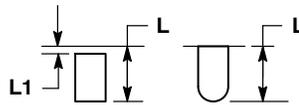


BOTTOM VIEW

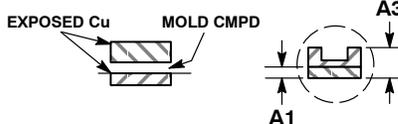
SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS



DETAIL A
ALTERNATE
CONSTRUCTIONS



DETAIL B
ALTERNATE
CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.65	0.85
A1	0.00	0.05
A3	0.22 REF	
b	0.20	0.30
D	3.00 BSC	
D2	1.30	1.50
E	3.00 BSC	
E2	1.30	1.50
e	0.50 BSC	
K	0.20	---
L	0.30	0.50
L1	0.00	0.15

GENERIC
MARKING DIAGRAM*



- XXXXX = Specific Device Code
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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